## 15 AMP (SMT) <br> MINIATURE <br> PC BOARD RELAY

## FEATURES

- High performance
- Low seated height
- Flux tight version
- Class F insulation $\left(155^{\circ} \mathrm{C}\right)$ standard
- UL, CUR file E43203
- TUV File R50161256


## CONTACTS

| Arrangement | SPST (1 Form A) <br> SPDT (1 Form C) |
| :---: | :---: |
| Ratings | Form A and C <br> Max. switched power: 210 W or 2770 VA <br> Max. switched current: 15 A AC, 7 A DC <br> Max. switched voltage: 30 VDC or 300 VAC |
| UL/CUR <br> TUV | 1 Form A <br> 15 A at 125 VAC , general use <br> 10 A at 277 VAC, general use, 100,000 cycles <br> TV - 5120 VAC <br> 1/2 HP at 125 VAC <br> 125 VA at 120 VAC Pilot Duty, 100k cycles (N.O.) <br> 1 Form C <br> 10 A at 277 VAC, general use, 100,000 cycles <br> $1 / 2 \mathrm{HP}$ at 125 VAC N.O. <br> 125 VA at 120 VAC Pilot Duty, 100k cycles (N.O.) <br> 1 Form A <br> 10 A at 277 VAC , Resistive, 25 k cycles, $85^{\circ} \mathrm{C}$ <br> 1 Form C <br> 5 A at 250VAC, Resistive, 25 k cycles, $85^{\circ} \mathrm{C}$ <br> 10 A at 277 VAC , Resistive, 10 k cycles, $85^{\circ} \mathrm{C}$ <br> 12 A at 125 VAC , Resistive, 10 k cycles, $85^{\circ} \mathrm{C}$ |
| Material | Silver tin oxide (gold plating available) |
| Resistance | < 100 milliohms initially <br> (24 V, 1 A method) |

## GENERAL DATA

| Life Expectancy Mechanical Electrical | $\begin{aligned} & 1 \times 10^{7} \\ & 1 \times 105 \text { at } 10 \text { A } 277 \text { VAC Res. } \end{aligned}$ |
| :---: | :---: |
| Operate Time | 10 ms max. |
| Release Time | 5 ms max. (with no coil suppression) |
| Dielectric Strength (at sea level for 1 min .) | 1500 Vrms contact to coil 1000 Vrms across contacts |
| Insulation Resistance | 100 megohms min. at 500 VDC, $50 \%$ RH |
| Dropout | Greater than $10 \%$ of nominal coil voltage |
| Ambient Temperature <br> Operating <br> Storage | At nominal coil voltage $-40^{\circ} \mathrm{C}\left(-40^{\circ} \mathrm{F}\right)$ to $110^{\circ} \mathrm{C}\left(230^{\circ} \mathrm{F}\right)$ <br> $-40^{\circ} \mathrm{C}\left(-40^{\circ} \mathrm{F}\right)$ to $155^{\circ} \mathrm{C}\left(311^{\circ} \mathrm{F}\right)$ |
| Vibration | $0.062{ }^{\text {" }}$ DA at $10-55 \mathrm{~Hz}$ |
| Shock | 10 g |
| Enclosure | P.B.T. polyester |
| Terminals | Tinned copper alloy, P.C. |
| Max. Solder Temp. | $270^{\circ} \mathrm{C}$ ( $518^{\circ} \mathrm{F}$ ) |
| Max. Solder Time | 5 seconds |
| Weight | 10 g |

## COIL

| Power |  |
| :--- | :--- |
| At Pickup Voltage <br> Max Continuous <br> Dissipation | 203 mW |
| Temperature Rise | $3 \mathrm{~W}^{\circ}$ at $20^{\circ} \mathrm{C}\left(68^{\circ} \mathrm{F}\right)$ |
| Temperature | Max. $\left.158^{\circ} \mathrm{F}\right)$ at nominal coil voltage |

## NOTES

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1. All values at }2\mp@subsup{0}{}{\circ}\textrm{C}(6\mp@subsup{8}{}{\circ}\textrm{F})\mathrm{ .
2. Relay may pull in with less than "Must Operate" value.
3. Unsealed relays should not be dip cleaned.
4. Specifications subject to change without notice.
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RELAY ORDERING DATA

## STANDARD RELAYS

| COIL SPECIFICATIONS |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: |
| Nominal Coil <br> VDC | Must Operate <br> VDC | Max Continuous <br> VDC | Coil Resistance <br> $\pm 10 \%$ |  |
| 5 | 3.8 | 11.2 | 70 | AZ943S-1CH-5DF |
| 6 | 4.5 | 13.4 | 100 | AZ943S-1CH-6DF |
| 9 | 6.8 | 20.1 | 225 | AZ943S-1CH-9DF |
| 12 | 9.0 | 26.8 | 400 | AZ943S-1CH-12DF |
| 18 | 13.5 | 40.2 | 900 | AZ943S-1CH-18DF |
| 24 | 18.0 | 53.4 | 1,600 | AZ943S-1CH-24DF |
| 48 | 36.0 | 107.3 | 6,400 | AZ943S-1CH-48DF |

* Substitute " 1 AH " in place of " 1 CH " to indicate 1 Form A contact. Add suffix "G" for gold plated contacts.


## MECHANICAL DATA



Dimensions in inches with metric equivalents in parentheses. Tolerance: $\pm .010^{\prime \prime}$


## Notes

The soldering profile to the left is an example and is just to show one of various profiles AZ943S has been tested with.

In order to make sure AZ943S fits to a specific profile, we strongly recommend to test under the real environment

